LM140LQML Series 3-Terminal Positive Regulators

Check for Samples: LM140LQML

FEATURES

- **Line Regulation of 0.04%/V**
- **Load Regulation of 0.01%/mA**
- **Output Voltage Tolerances of ±2% at T_j = 25°C and ±4% over the Temperature Range**
- **Output Current of 100 mA**
- **Internal Thermal Overload Protection**
- **Output Transistor Safe Area Protection**
- **Internal Short Circuit Current Limit**

DESCRIPTION

The LM140L series of three terminal positive regulators is available with several fixed output voltages making them useful in a wide range of applications. The LM140LA is an improved version of the LM78LXX series with a tighter output voltage tolerance (specified over the full military temperature range), higher ripple rejection, better regulation and lower quiescent current. The LM140LA regulators have ±2% V_{OUT} specification, 0.04%/V line regulation, and 0.01%/mA load regulation. When used as a zener diode/resistor combination replacement, the LM140LA usually results in an effective output impedance improvement of two orders of magnitude, and lower quiescent current. These regulators can provide local on card regulation, eliminating the distribution problems associated with single point regulation. The voltages available allow the LM140LA to be used in logic systems, instrumentation, Hi-Fi, and other solid state electronic equipment. Although designed primarily as fixed voltage regulators, these devices can be used with external components to obtain adjustable voltages and currents.

With adequate heat sinking the regulator can deliver 100 mA output current. Current limiting is included to limit the peak output current to a safe value. Safe area protection for the output transistor is provided to limit internal power dissipation. If internal power dissipation becomes too high for the heat sinking provided, the thermal shut-down circuit takes over, preventing the IC from overheating.

Output Voltage Options

Device ID	Output Voltage
LM140LA-5.0	5V
LM140LA-12	12V
LM140LA-15	15V

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Connection Diagrams

TO-39 Metal Can Package

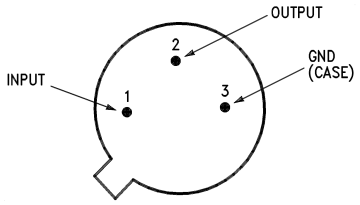
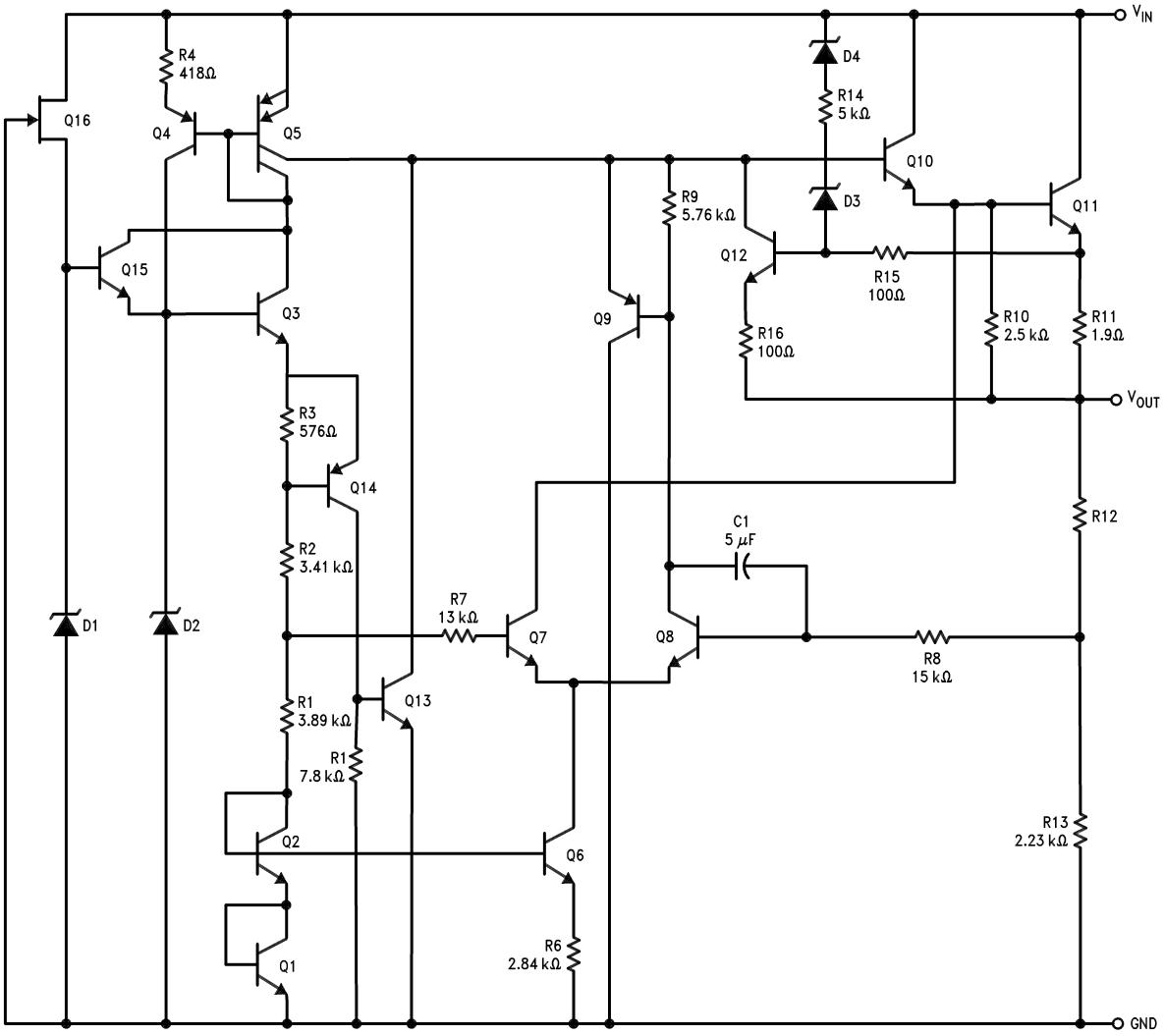


Figure 1. Bottom View
See Package NDT0003A

Equivalent Circuit



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings[1]

Input Voltage			35V
Internal Power Dissipation[2]			Internally Limited
Operating Temperature Range			$-55°C \le T_A \le +125°C$
Maximum Junction Temperature			+150°C
Storage Temperature Range			$-65°C \le T_A \le +150°C$
Lead Temperature (Soldering, 10 sec.)			+300°C
Thermal Resistance	θ_{JA}	Still Air @ 0.5W	201°C/W
		500LF / Min Air Flow @ 0.5W	79°C/W
	θ_{JC} (@ 1.0W)		38°C/W
ESD Susceptibility[3]			TBD

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not specify specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

(2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.

(3) Human body model, 100pF discharged through 1.5KΩ

Quality Conformance Inspection

Mil-Std-883, Method 5005 - Group A

Subgroup	Description	Temp °C
1	Static tests at	25
2	Static tests at	125
3	Static tests at	-55
4	Dynamic tests at	25
5	Dynamic tests at	125
6	Dynamic tests at	-55
7	Functional tests at	25
8A	Functional tests at	125
8B	Functional tests at	-55
9	Switching tests at	25
10	Switching tests at	125
11	Switching tests at	-55
12	Settling time at	25
13	Settling time at	125
14	Settling time at	-55

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LM140LA-5.0 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. DC: V_I = 10V, I_L = 40mA

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
I_Q	Quiescent Current				4.5	mA	1
					4.2	mA	2
V_O	Output Voltage			4.9	5.1	V	1
		V_I = 20V, I_L = 5mA		4.8	5.2	V	1, 2, 3
		V_I = 20V, I_L = 100mA		4.8	5.2	V	1, 2, 3
		V_I = 7.2V, I_L = 5mA		4.8	5.2	V	1, 2, 3
		V_I = 7.2V, I_L = 100mA		4.8	5.2	V	1, 2, 3
R_{Load}	Load Regulation	5mA ≤ I_L ≤ 40 mA		-20	20	mV	1
		5mA ≤ I_L ≤ 100mA		-40	40	mV	1
R_{Line}	Line Regulation	I_L = 100mA, 7.5V ≤ V_I ≤ 25V		-30	30	mV	1
		7V ≤ V_I ≤ 25V		-30	30	mV	1
ΔI_Q	Quiescent Current Change	5mA ≤ I_L ≤ 40mA		-0.1	0.1	mA	1, 2, 3
		7.5V ≤ V_I ≤ 35V		-0.5	0.5	mA	1

LM140LA-5.0 Electrical Characteristics AC Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
RR	Ripple Rejection	f = 120Hz, e_i = $1V_{RMS}$		55		dB	4

LM140LA-12 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. DC: V_I = 19V, I_L = 40mA

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
I_Q	Quiescent Current				4.5	mA	1
					4.2	mA	2
V_O	Output Voltage			11.75	12.25	V	1
		V_I = 27V, I_L = 5mA		11.5	12.5	V	1, 2, 3
		V_I = 27V, I_L = 100mA		11.5	12.5	V	1, 2, 3
		V_I = 14.5V, I_L = 5mA		11.5	12.5	V	1, 2, 3
		V_I = 14.5V, I_L = 100mA		11.5	12.5	V	1, 2, 3
R_{Load}	Load Regulation	5mA ≤ I_L ≤ 40mA		-40	40	mV	1
		5mA ≤ I_L ≤ 100mA		-80	80	mV	1
R_{Line}	Line Regulation	I_L = 100mA, 14.5V ≤ V_I ≤ 30V		-65	65	mV	1
		14.2V ≤ V_I ≤ 30V		-65	65	mV	1
ΔI_Q	Quiescent Current Change	5mA ≤ I_L ≤ 40mA		-0.1	0.1	mA	1, 2, 3
		14.3V ≤ V_I ≤ 35V		-0.5	0.5	mA	1

LM140LA-12 Electrical Characteristics AC Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
RR	Ripple Rejection	f = 120Hz, e_i = $1V_{RMS}$		47		dB	4

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LM140LA-15 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. DC: V_I = 23V, I_L = 40mA

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
I_Q	Quiescent Current				4.5	mA	1
					4.2	mA	2
V_O	Output Voltage			14.7	15.3	V	1
		V_I = 30V, I_L = 5mA		14.4	15.6	V	1, 2, 3
		V_I = 30V, I_L = 100mA		14.4	15.6	V	1, 2, 3
		V_I = 17.6V, I_L = 5mA		14.4	15.6	V	1, 2, 3
		V_I = 17.6V, I_L = 100mA		14.4	15.6	V	1, 2, 3
R_{Load}	Load Regulation	5mA ≤ I_L ≤ 40mA		-50	50	mV	1
		5mA ≤ I_L ≤ 100mA		-100	100	mV	1
R_{Line}	Line Regulation	I_L = 100mA, 17.3V ≤ V_I ≤ 30V		-70	70	mV	1
		17.3V ≤ V_I ≤ 30V		-70	70	mV	1
ΔI_Q	Quiescent Current Change	5mA ≤ I_L ≤ 40mA		-0.1	0.1	mA	1, 2, 3
		17.5V ≤ V_I ≤ 35V		-0.5	0.5	mA	1

LM140LA-15 Electrical Characteristics AC Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
RR	Ripple Rejection*f*	f = 120Hz, e_I = $1V_{RMS}$		47		dB	4

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Typical Performance Characteristics

Maximum Average Power Dissipation

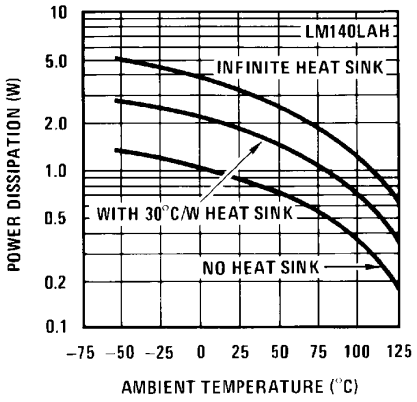


Figure 2.

Maximum Average Power Dissipation

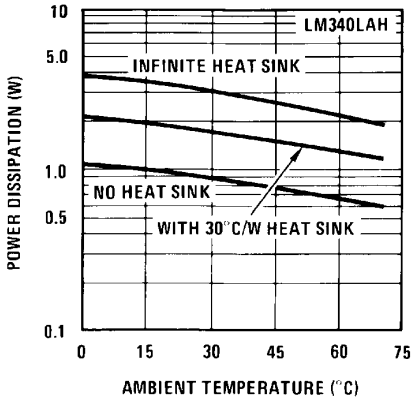


Figure 3.

Peak Output Current

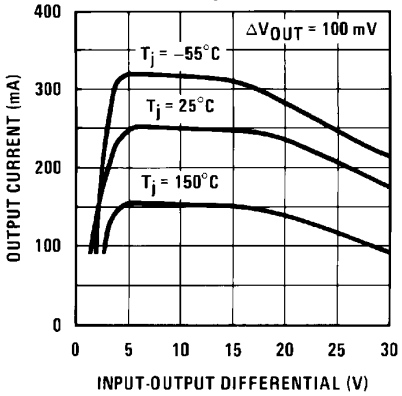


Figure 4.

Dropout Voltage

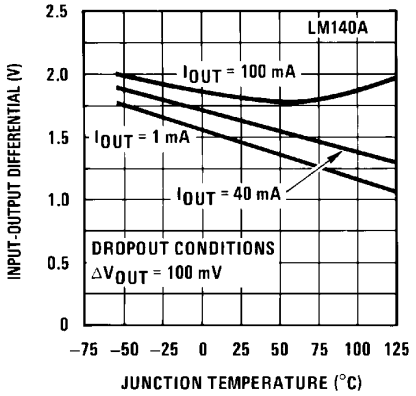


Figure 5.

Output Impedance

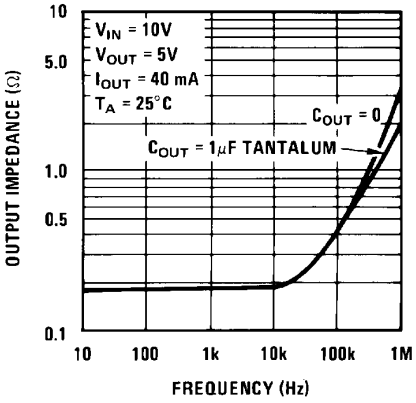


Figure 6.

Ripple Rejection

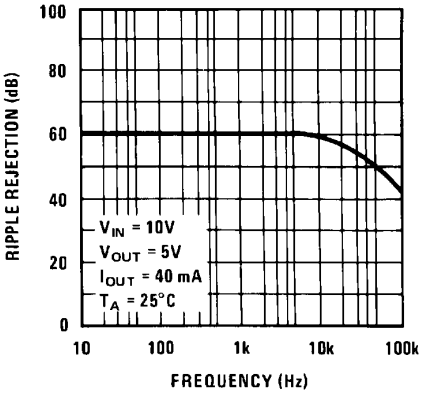


Figure 7.

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Typical Performance Characteristics (continued)

Quiescent Current

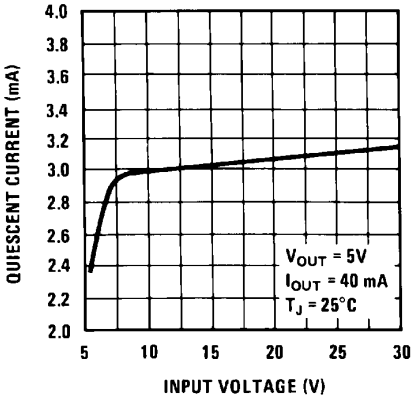


Figure 8.

Quiescent Current

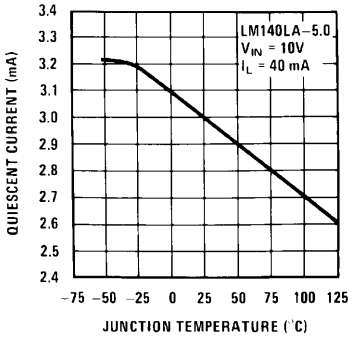
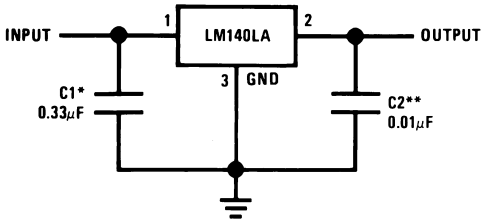


Figure 9.

TYPICAL APPLICATIONS

NOTE

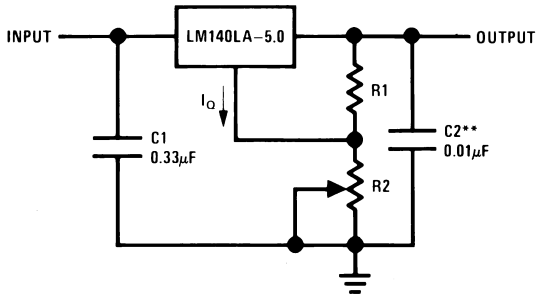
It is recommended that a minimum load capacitor of 0.01 µF be used to limit the high frequency noise bandwidth.



*Required if the regulator is located far from the power supply filter.

**Human body model, 100pF discharged through 1.5KΩ

Figure 10. Fixed Output Regulator



V_{OUT} = 5V + (5V/R1 + I_O) R2
5V/R1 = 3 I_O load regulation (L,) [(R1 + R2)/R1] (L, of LM140LA-5.0)

Figure 11. Adjustable Output Regulator

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Revision History

Released	Revision	Section	Originator	Changes
03/10/06	A	New release to corporate format	L. Lytle	3 MDS data sheets converted into one Corp. data sheet format. Drift tables were removed from electrical characteristics since not performed on 883 product. MDS data sheets MNLM140LA-05-H Rev. 0B0, MNLM140LA-12-H Rev. 0B0 and MNLM140LA-15-H Rev. 0B0. will be archived.
05/02/13	A			Changed layout of National Data Sheet to TI format.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM140LAH-12/883	Active	Production	TO (NDT) | 3	20 | JEDEC TRAY (5+1)	No	Call TI	Level-1-NA-UNLIM	-55 to 125	LM140LAH-12/883 Q ACO LM140LAH-12/883 Q >T
LM140LAH-15/883	Active	Production	TO (NDT) | 3	20 | JEDEC TRAY (5+1)	No	Call TI	Level-1-NA-UNLIM	-55 to 125	LM140LAH-15/883 Q ACO LM140LAH-15/883 Q >T
LM140LAH5.0/883	Active	Production	TO (NDT) | 3	20 | JEDEC TRAY (5+1)	No	Call TI	Level-1-NA-UNLIM	-55 to 125	LM140LAH5.0/883 Q ACO LM140LAH5.0/883 Q >T

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

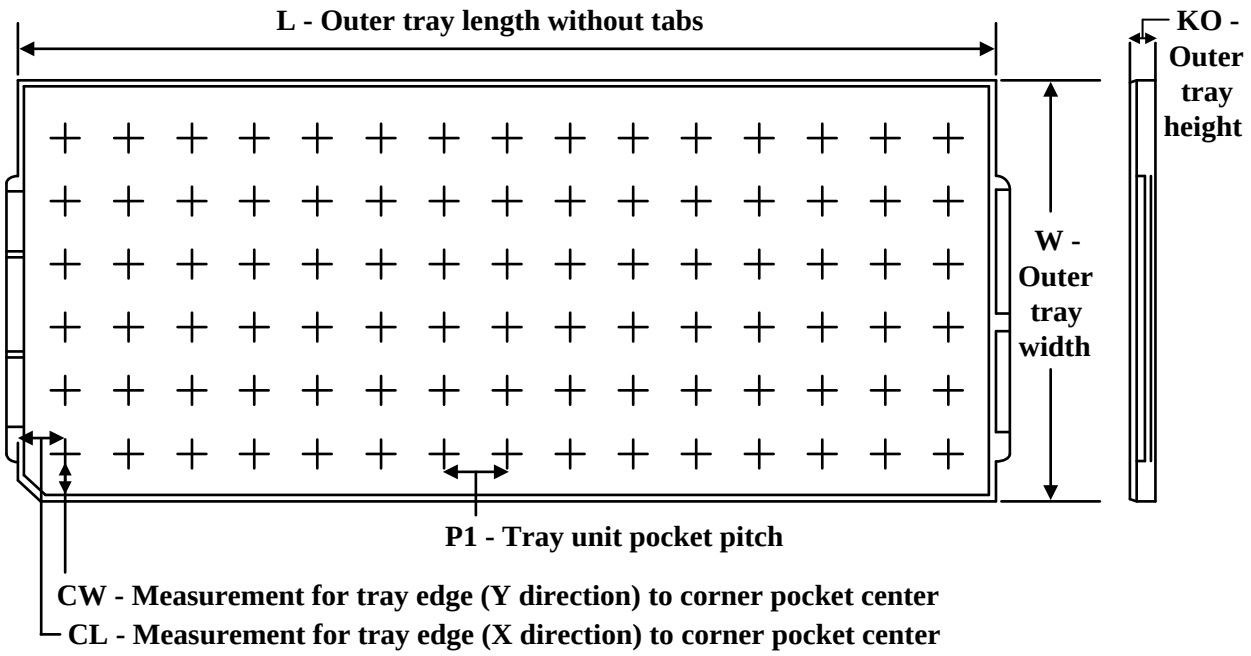
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TRAY

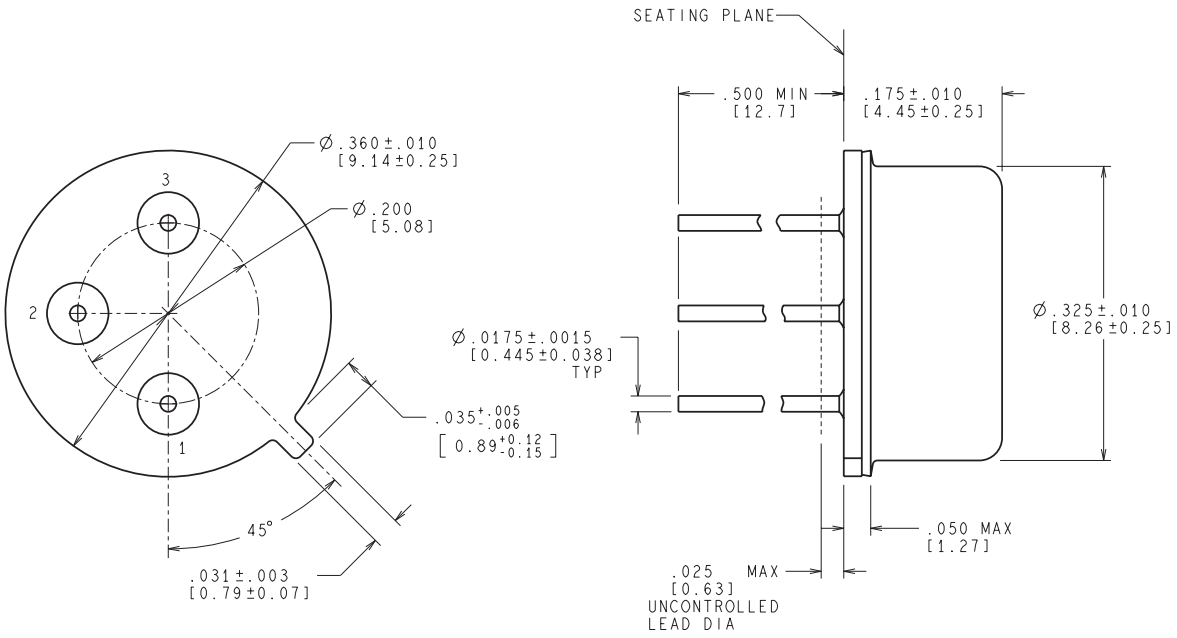


Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
LM140LAH-12/883	NDT	TO-CAN	3	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM140LAH-15/883	NDT	TO-CAN	3	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM140LAH5.0/883	NDT	TO-CAN	3	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54

NDT0003A



CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS

MIL-PRF-38535
CONFIGURATION CONTROL

H03A (Rev D)

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